APPLICA	BLE STAN	IDARD								
	Operating Temperature Range Voltage		-55 °C to 85 °C (1) Ter			orage emperature Range		-10 °C to	60 °C	(2)
Rating						orage Humidity Range		Relative humidity 8	5% max	
	Current		Signal Contact: 0.5 A Power Contact: 3.0A			perating Humidity Range		(Not dewed)		
	l		SPEC	IFICA	TION	S				
IT	ΓEM		TEST METHOD				REQU	IREMENTS	QT	AT
CONSTR	UCTION									
General Exa	mination	Visually and by measuring instrument.				Accord	ing to drawing	j .	×	×
Marking		Confirmed visually.							×	×
	C CHARAC									
Contact Resistance		100 mA(DC or 1000Hz)			Signal Contact : $70m\Omega$ MAX. Power Contact : $20m\Omega$ MAX.			×	_	
Insulation Resistance		Signal Contact : 100 V DC. Power Contact : 250 V DC 1				Signal Contact : 100 M Ω MIN. Power Contact : 1000 M Ω MIN. 1			×	_
Voltage Proof		Signal Contact : 150 V AC for 1 min. Power Contact : 600 V AC for 1 min. 1				No flashover or breakdown.			×	× _
MECHAN	ICAL CHAR			<u> </u>					^	
Insertion and Withdrawal Forces		Measured by applicable connector.				Insertion Force: 9 N MAX.1 Withdrawal Force: 1 N MIN.				T -
Mechanical Operation		100 times insertions and extractions.				Contact Resistance:			×	+-
						Signal Contact : 80m Ω MAX. 1 Power Contact : 30m Ω MAX. 2 No damage, crack and looseness of parts.				
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude: 0.75 mm, 10 cycles for 3 axial directions.				 No electrical discontinuity of 1 µs. No damage, crack and looseness of parts. 			×	-
		490 m/s ² , duration of pulse 11 ms at 3 times for 3 both axial directions.							×	<u> </u>
ENVIRON	IMENTAL C		TERISTICS							
Damp Heat		1	at 40±2 °C, 90 ~ 95 %	, 96 h	٦.	① Cor	ntact Resistar	ice:	×	Τ-
(Steady state)		, , ,					ignal Contact			
Rapid Change of		Temperature -55 → +85 °C				Power Contact: 30m Ω MAX.			×	T -
Temperature	Э	Time		nin.		_	ulation Resist			
		under 5 cycles. (Relocation time to chamber : within 2~3 MIN)			△1 F	Signal Contac Power Contac	t: 1000 MΩ MIN.			
Cold		Exposed at -55°C, 96 h			③ No damage, crack and looseness of parts. ① Contact Resistance: Signal Contact: 80m Ω MAX.			×	<u> </u>	
Dry Heat		Exposed at 85°C, 96 h				Power Contact: 30m Ω MAX. No damage, crack and looseness of parts.			×	
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h.			96 h.	No defect such as corrosion which impairs the function of connector.				+-
			(Test standard: IEC 68) /1							
						② Cor	ntact Resistar	ice:		
						Λ.	ignal Contact			
Resistance to		1)Reflow soldering :				1 Power Contact: 30m Ω MAX. No deformation of case of excessive			×	+
Soldering Heat		Peak TMP : 260°CMAX				looseness of the terminal.				
		Reflow	TMP: 220°CMIN for 60sec							
			ing irons: 360°C MAX. for 5	sec.						
Solderability		Soldered at solder temperature 240±3°C for immersion duration, 3 sec.				A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.			×	-
COUNT D		ESCRIPTION OF REVISIONS DESIGN						DA	TE	
/\ 13				TS. 00			KN. SHIBUYA	+	9. 09	
		ature rise caused by current-carrying.			. 3. 3.	APPROVED		HS. OKAWA		9. 02
	(2) "STORAGE" m	eans a long-t	erm storage state for the unused pro	oduct			CHECKED	KN. SHIBUYA		9. 02
	before assemb	to PCB.				DESIGNED	TS. 00N0		9. 02	
Unless otherwise specified, re			fer to IEC 60512. 1			DRAWN		TS. 00N0		9. 02
			surance Test X:Applicable Te			RAWING NO.		ELC-353558-00-00		
LDC SPECIFI			CATION SHEET		PART NO.		FX23-20S-0. 5SV10			
HS HIR		OSE ELECTRIC CO., LTD.			CODE NO.		CL573-3301-4-00 1			
		= = ; = = = -								

